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Vishay Siliconix

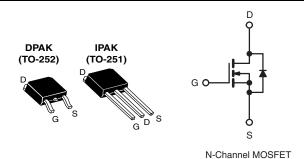
COMPLIANT

HALOGEN

FREE

Power MOSFET

| PRODUCT SUMMARY | | | | | | |
|----------------------------|-------------------------|------------------------------|--|--|--|--|
| V _{DS} (V) | 60 | 60 | | | | |
| R _{DS(on)} (Ω) | V _{GS} = 5.0 V | V _{GS} = 5.0 V 0.10 | | | | |
| Q _g (Max.) (nC) | 18 | 18 | | | | |
| Q _{gs} (nC) | 4.5 | 4.5 | | | | |
| Q _{gd} (nC) | 12 | 12 | | | | |
| Configuration | Sing | Single | | | | |



FEATURES

- Dynamic dV/dt rating
- Surface mount (IRLR024, SiHLR024)
- Straight lead (IRLU024, SiHLU024)
- Available in tape and reel
- · Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRLU, SiHLU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

| ORDERING INFORMATION | | | | | | |
|---------------------------------|---------------|-----------------|---------------------------|---------------|--|--|
| Package | DPAK (TO-252) | DPAK (TO-252) | DPAK (TO-252) | IPAK (TO-251) | | |
| Lead (Pb)-free and Halogen-free | - | SiHLR024TRL-GE3 | SiHLR024TR-GE3 | SiHLU024-GE3 | | |
| Load (Dh) fron | IRLR024PbF | - | IRLR024TRPbF ^a | IRLU024PbF | | |
| Lead (Pb)-free | SiHLR024-E3 | - | SiHLR024T-E3 a | SiHLU024-E3 | | |

Note

a. See device orientation.

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | | | |
|--|--------------------------|---|-----------------------------------|-------------|--------|--|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | | |
| Drain-Source Voltage | | | V_{DS} | 60 | V | | |
| Gate-Source Voltage | | | V_{GS} | ± 10 | 7 ° | | |
| Continuous Drain Current | V _{GS} at 5.0 V | $T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$ | I- | 14 | | | |
| Continuous Drain Current | V _{GS} at 5.0 V | T _C = 100 °C | l _D | 9.2 | Α | | |
| Pulsed Drain Current ^a | | | I _{DM} | 56 | | | |
| Linear Derating Factor | | | | 0.33 | W/°C | | |
| Linear Derating Factor (PCB Mount) e | | | | 0.020 |] W/ C | | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 53 | mJ | | |
| Maximum Power Dissipation $T_C = 25 ^{\circ}C$ | | | В | 42 | W | | |
| Maximum Power Dissipation (PCB Mount) e T _A = 25 °C | | | P_D | 2.5 |] vv | | |
| Peak Diode Recovery dV/dt ^c | | | dV/dt | 4.5 | V/ns | | |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | -55 to +150 | °C | | |
| Soldering Recommendations (Peak Temperature) d for 10 s | | | | 260 |] | | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 541 μ H, R_g = 25 Ω , I_{AS} = 14 A (see fig. 12).
- c. $I_{SD} \le 17$ A, $dI/dt \le 140$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).

IRLR024, IRLU024, SiHLR024, SiHLU024

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| THERMAL RESISTANCE RATINGS | | | | | | |
|--|-------------------|------|------|------|------|--|
| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT | |
| Maximum Junction-to-Ambient | R _{thJA} | - | - | 110 | | |
| Maximum Junction-to-Ambient (PCB Mount) ^a | R _{thJA} | - | - | 50 | °C/W | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | - | 3.0 | | |

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

| PARAMETER | SYMBOL | TES | MIN. | TYP. | MAX. | UNIT | |
|---|-----------------------|---|---|------|-------|-------|------------------|
| Static | | | | , | ı | ı | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 60 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | e to 25 °C, I _D = 1 mA | - | 0.068 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | · V _{GS} , I _D = 250 μA | 1.0 | - | 2.0 | V |
| Gate-Source Leakage | I _{GSS} | , | V _{GS} = ± 10 V | - | - | ± 100 | nA |
| Zava Cata Valtaga Dvain Cuvvant | | V _{DS} : | V _{DS} = 60 V, V _{GS} = 0 V | | - | 25 | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 48 V | , V _{GS} = 0 V, T _J = 125 °C | - | - | 250 | μA |
| Durin On the On Olete Business | 5 | $V_{GS} = 5.0 \text{ V}$ | I _D = 8.4 A ^b | - | - | 0.10 | |
| Drain-Source On-State Resistance | $R_{DS(on)}$ | V _{GS} = 4.0 V | I _D = 7.0 A ^b | - | - | 0.14 | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} = | 25 V, I _D = 8.4 A ^b | 7.3 | - | - | S |
| Dynamic | | • | | | I. | I. | |
| Input Capacitance | C _{iss} | | $V_{GS} = 0 \text{ V},$ | | 870 | - | pF |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ | | - | 360 | - | |
| Reverse Transfer Capacitance | C _{rss} | f = 1. | f = 1.0 MHz, see fig. 5 | | 53 | - | |
| Total Gate Charge | Qg | | | - | - | 18 | nC |
| Gate-Source Charge | Q _{gs} | $V_{GS} = 5.0 \text{ V}$ | $V_{GS} = 5.0 \text{ V}$ $I_D = 17 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 b | | - | 4.5 | |
| Gate-Drain Charge | Q _{gd} | see lig. 6 and 13 - | | - | - | 12 | |
| Turn-On Delay Time | t _{d(on)} | | | - | 11 | - | nc |
| Rise Time | t _r | V _{DD} : | = 30 V, I _D = 17 A, | - | 110 | - | |
| Turn-Off Delay Time | t _{d(off)} | $R_g = 9.0 \ \Omega$, $R_D = 1.7 \ \Omega$, see fig. 10 b | | - | 23 | - | ns |
| Fall Time | t _f | | | - | 41 | - | |
| Internal Drain Inductance | L _D | Between lead, 6 mm (0.25") from package and center of die contact | | - | 4.5 | - | -11 |
| Internal Source Inductance | L _S | | | - | 7.5 | - | - nH |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 14 | - A |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 56 | A |
| Body Diode Voltage | V_{SD} | T _J = 25 °C | , I _S = 14 A, V _{GS} = 0 V ^b | - | - | 1.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T 05 °C 1 | 17 A all/alt 100 A / h | - | 130 | 260 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | $T_J = 25 ^{\circ}\text{C}$, $I_F = 17 ^{\circ}\text{A}$, $dI/dt = 100 ^{\circ}\text{A/µs}$ | | - | 0.75 | 1.5 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D) | | | | | L _D) |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

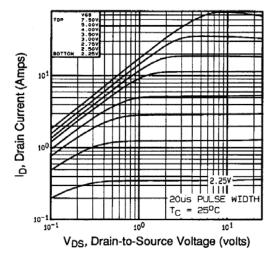


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

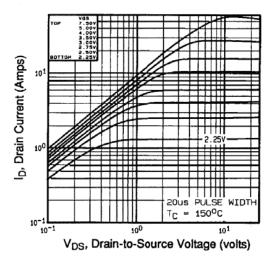


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

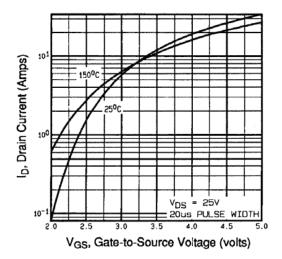


Fig. 3 - Typical Transfer Characteristics

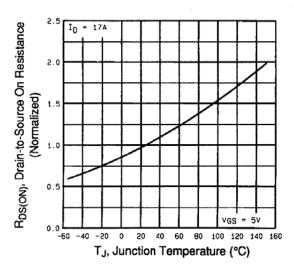


Fig. 4 - Normalized On-Resistance vs. Temperature



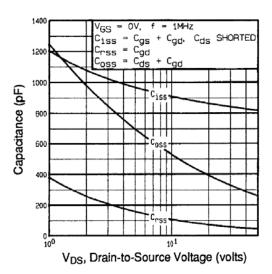


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

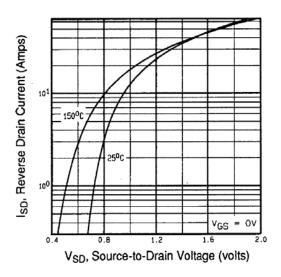


Fig. 7 - Typical Source-Drain Diode Forward Voltage

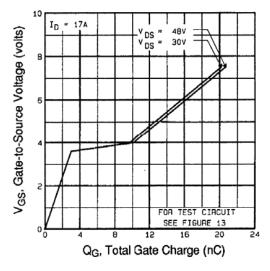


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

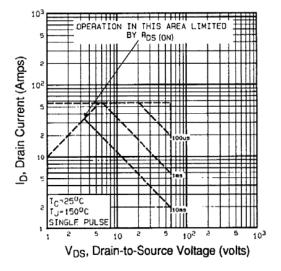


Fig. 8 - Maximum Safe Operating Area

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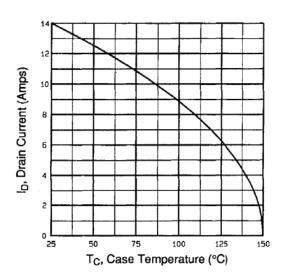


Fig. 9 - Maximum Drain Current vs. Case Temperature

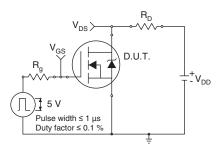


Fig. 10a - Switching Time Test Circuit

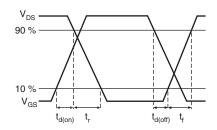


Fig. 10b - Switching Time Waveforms

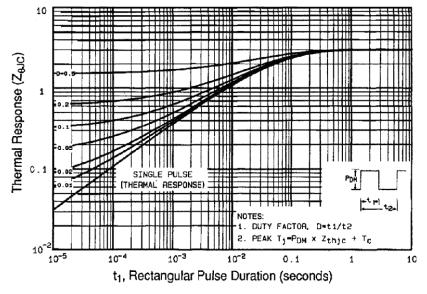


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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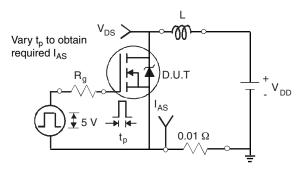


Fig. 12a - Unclamped Inductive Test Circuit

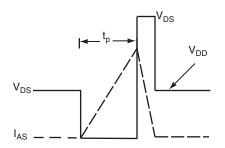


Fig. 12b - Unclamped Inductive Waveforms

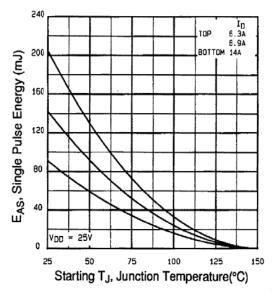


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

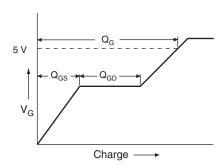


Fig. 13a - Basic Gate Charge Waveform

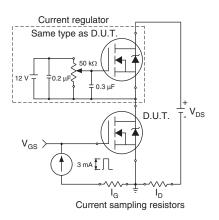
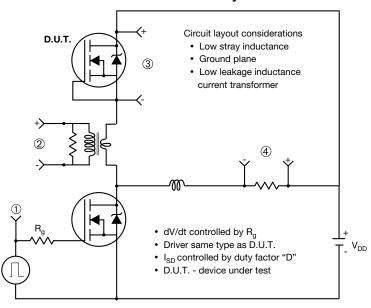


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



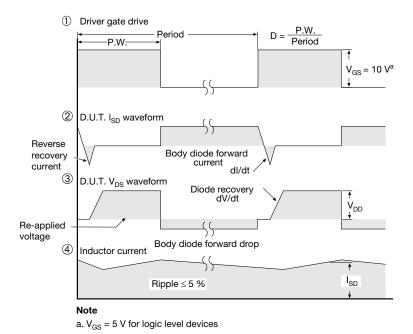
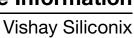


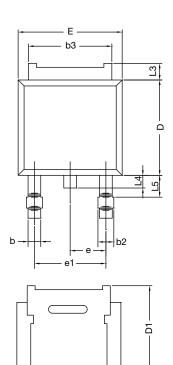
Fig. 14 - For N-Channel

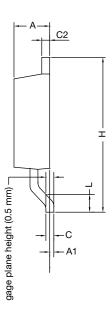
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TO-252AA Case Outline





| | MILLIMETERS | | INC | HES |
|---------------------------------|-------------|-------|-----------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| Α | 2.18 | 2.38 | 0.086 | 0.094 |
| A1 | - | 0.127 | - | 0.005 |
| b | 0.64 | 0.88 | 0.025 | 0.035 |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 |
| С | 0.46 | 0.61 | 0.018 | 0.024 |
| C2 | 0.46 | 0.89 | 0.018 | 0.035 |
| D | 5.97 | 6.22 | 0.235 | 0.245 |
| D1 | 4.10 | - | 0.161 | - |
| E | 6.35 | 6.73 | 0.250 | 0.265 |
| E1 | 4.32 | - | 0.170 | - |
| Н | 9.40 | 10.41 | 0.370 | 0.410 |
| e | 2.28 BSC | | 0.090 BSC | |
| e1 | 4.56 | BSC | 0.180 | BSC |
| L | 1.40 | 1.78 | 0.055 | 0.070 |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 |
| L4 | - | 1.02 | - | 0.040 |
| L5 | 1.01 | 1.52 | 0.040 | 0.060 |
| ECN: T16-0236-Rev. P, 16-May-16 | | | | |

DWG: 5347 Notes

• Dimension L3 is for reference only.



TO-251AA (HIGH VOLTAGE)



Section B - B and C - C

| | MILLIN | METERS | INC | HES |
|------|--------|--------|-------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| Α | 2.18 | 2.39 | 0.086 | 0.094 |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 |
| b | 0.64 | 0.89 | 0.025 | 0.035 |
| b1 | 0.65 | 0.79 | 0.026 | 0.031 |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 |
| b3 | 0.76 | 1.04 | 0.030 | 0.041 |
| b4 | 4.95 | 5.46 | 0.195 | 0.215 |
| С | 0.46 | 0.61 | 0.018 | 0.024 |
| c1 | 0.41 | 0.56 | 0.016 | 0.022 |
| c2 | 0.46 | 0.86 | 0.018 | 0.034 |
| D | 5.97 | 6.22 | 0.235 | 0.245 |

| | MILLIN | IETERS | INC | HES | |
|------|----------|--------|----------|-------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| D1 | 5.21 | - | 0.205 | - | |
| Е | 6.35 | 6.73 | 0.250 | 0.265 | |
| E1 | 4.32 | - | 0.170 | - | |
| е | 2.29 BSC | | 2.29 BSC | | |
| L | 8.89 | 9.65 | 0.350 | 0.380 | |
| L1 | 1.91 | 2.29 | 0.075 | 0.090 | |
| L2 | 0.89 | 1.27 | 0.035 | 0.050 | |
| L3 | 1.14 | 1.52 | 0.045 | 0.060 | |
| θ1 | 0' | 15' | 0' | 15' | |
| θ2 | 25' | 35' | 25' | 35' | |
| | | | | | |

ECN: S-82111-Rev. A, 15-Sep-08

DWG: 5968

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.

Document Number: 91362 Revision: 15-Sep-08



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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